Implementation of a Single-Phase Electronic Watt-Hour Meter Using the MSP430F6736

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ABSTRACT
This application report describes the implementation of a single phase electronic electricity meter using the Texas Instruments MSP430F673x metering processor. It also includes the necessary information with regard to metrology software and hardware procedures for this single chip implementation.

WARNING
Failure to adhere to these steps and/or not heed the safety requirements at each step may lead to shock, injury, and damage to the hardware. Texas Instruments is not responsible or liable in any way for shock, injury, or damage caused due to negligence or failure to heed this advice.

Project collateral and source code discussed in this application report can be downloaded from the following URL: http://www.ti.com/lit/zip/slaa517.

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Introduction

The MSP430F6736 device is the latest metering system-on-chip (SoC), that belongs to the MSP430F67xx family of devices. This family of devices belongs to the powerful 16-bit MSP430F6xxx platform bringing in a lot of new features and flexibility to support robust single, dual and 3-phase metrology solutions. This application report, however, discusses the implementation of 1-phase solution only. These devices find their application in energy measurement and have the necessary architecture to support them.

The F6736 has a powerful 25 MHz CPU with MSP430CPUx architecture. The analog front end consists of up to three 24-bit ΔΣ analog-to-digital converters (ADC) based on a second order sigma-delta architecture that supports differential inputs. The sigma-delta ADCs (ΣΔ24) operate independently and are capable to output 24-bit result. They can be grouped together for simultaneous sampling of voltage and currents on the same trigger. In addition, it also has an integrated gain stage to support gains up to 128 for amplification of low-output sensors. A 32-bit x 32-bit hardware multiplier on this chip can be used to further accelerate math intensive operations during energy computation. The software supports calculation of various parameters for single phase energy measurement. The key parameters calculated during energy measurements are: RMS current and voltage, active and reactive power and energies, power factor and frequency. A complete metrology source code is provided that can be downloaded from the following URL: http://www.ti.com/lit/zip/slaa517.

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1 Introduction

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2 System Diagrams

Figure 1 shows typical connections of electronic electricity (energy/e-) meters in real life applications. The AC voltages supported are 230 V, 120 V, 50 Hz, 60 Hz and the associated currents. The labels Line (L) and Neutral (N) are indicative of low voltage AC coming from the utilities.
More information on the current and voltage sensors, ADCs, and so forth are discussed in the following sections.

Figure 2 depicts the block diagram that shows the high-level interface used for a single-phase energy meter application using the F6736. A single-phase two wire star connection to the mains is shown in this case with tamper detection. Current sensors are connected to each of the current channels and a simple voltage divider is used for corresponding voltages. The CT has an associated burden resistor that has to be connected at all times to protect the measuring device. The choice of the CT and the burden resistor is done based on the manufacturer and current range required for energy measurements. The choice of the shunt resistor value is determined by the current range, gain settings of the SD24 on the power dissipation at the sensors. The choice of voltage divider resistors for the voltage channel is selected to ensure the mains voltage is divided down to adhere to the normal input ranges that are valid for the MSP430™ SD24. For these numbers, see the MSP430x5xx/MSP430x6xx Family User's Guide (SLAU208) and the device-specific data sheet.
L and N refer to the line and neutral voltages and are interchangeable as long as the device is subject to only one voltage and not both simultaneously at its pins. The other signals of interest are the PULSE1 and PULSE2. They are used to transmit active and reactive energy pulses used for accuracy measurement and calibration.

3 Hardware Implementation

This section describes various pieces that constitute the hardware for the design of a working 1-phase energy meter using the F6736.

3.1 Power Supply

The MSP430 family of devices is ultra low-power microcontrollers from Texas Instruments. These devices support a number of low-power modes and improved power consumption during active mode when the CPU and other peripherals are active. The low-power feature of this device family allows the design of the power supply to be extremely simple and cheap. The power supply allows the operation of the energy meter powered directly from the mains. The next sub-sections discuss the various power supply options that are available to support your designs.

3.1.1 Resistor Capacitor (RC) Power Supply

Figure 3 shows a simple capacitor power supply for a single output voltage of 3.3 V directly from the mains voltage of 110 V and 220 V and 50 Hz and 60 Hz VRMS AC.
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Hardware Implementation

Appropriate values of resistor R20 and capacitor C28 are chosen based on the required output current drive of the power supply. Voltage from mains is directly fed to a RC based circuit followed by a rectification circuitry to provide a DC voltage for the operation of the MSP430. This DC voltage is regulated to 3.3 V for full speed operation of the MSP430. For the circuit above, the approximate drive provided about 12 mA. The design equations for the power supply are shown in the Capacitor Power Supplies section of MSP430 Family Mixed-Signal Microcontroller (SLAA024). If there is a need to slightly increase the current drive (< 20 mA), the capacitor values of C28 can be increased. If a higher drive is required, especially to drive RF technology, additional drive can be used either with an NPN output buffer or a transformer and switching-based power supply.

3.2 Analog Inputs

The MSP430 analog front end that consists of the ΣΔ ADC is differential and requires that the input voltages at the pins do not exceed ±920 mV (gain=1). In order to meet this specification, the current and voltage inputs need to be divided down. In addition, the SD24 allows a maximum negative voltage of -1 V, therefore, AC signals from mains can be directly interfaced without the need for level shifters. This sub-section describes the analog front end used for voltage and current channels.

3.2.1 Voltage Inputs

The voltage from the mains is usually 230 V or 110 V and needs to be brought down to a range of 1 V. The analog front end for voltage consists of spike protection varistors (not shown) followed by a simple voltage divider and a RC low-pass filter that acts like an anti-alias filter.

Figure 3. A Simple Capacitive Power Supply for the MSP430 Energy Meter

Figure 4. Analog Front End for Voltage Inputs
Figure 4 shows the analog front end for the voltage inputs for a mains voltage of 230 V. The voltage is brought down to approximately 700 mV RMS, which is 990 mV peak and fed to the positive input, adhering to the MSP430 ΣΔ analog limits. A common mode voltage of zero can be connected to the negative input of the ΣΔ. In addition, the ΣΔ has an internal reference voltage of 1.2 V that can be used externally and also as a common mode voltage if needed. GND is referenced to the Neutral voltage or Line voltage depending on the placement of the current sensor.

It is important to note that the anti-alias resistors on the positive and negative sides are different because, the input impedance to the positive terminal is much higher and, therefore, a lower value resistor is used for the anti-alias filter. If this is not maintained, a relatively large phase shift of several degrees would result.

3.2.2 Current Inputs

The analog front-end for current inputs is a little different from the analog front end for the voltage inputs. Figure 5 shows the analog front end used for the current channels I1 and I2.

![Figure 5. Analog Front End for Current Inputs](image)

Resistors R14 and R18 are the burden resistors that would be selected based on the current range used and the turns-ratio specification of the CT (not required for shunt). The value of the burden resistor for this design is around 13 Ω. The anti-aliasing circuitry consisting of R and C follows the burden resistor. The input signal to the converter is a fully differential input with a voltage swing of ± 920 mV maximum with gain of the converter set to 1. Similar to the voltage channels, the common mode voltage is selectable to either analog ground (GND) or internal reference on channels connected to LSP3 and LSP4.

4 Software Implementation

The software for the implementation of 1-phase metrology is discussed in this section. The first subsection discusses the set up of various peripherals of the MSP430. Subsequently, the entire metrology software is described as two major processes: foreground process and background process.

4.1 Peripherals Set Up

The major peripherals are the 24-bit sigma delta (SD24) ADC, clock system, timer, LCD, watchdog timer (WDT), and so forth.
4.1.1 SD24 Set Up

The F673x family has up to three independent sigma delta data converters. For a single phase system at least two $\Sigma\Delta$s are necessary to independently measure one voltage and current. The code accompanying this application report addresses the metrology for a 1-phase system with limited discussion to anti-tampering, however, the code supports the measurement of the neutral current. The clock to the SD24 ($f_m$) is derived from DCO running at 16 MHz. The sampling frequency is defined as $f_s = \frac{f_m}{OSR}$, the OSR is chosen to be 256 and the modulation frequency, $f_m$, is chosen as 1.1 MHz, resulting in a sampling frequency of 4.096 ksp. The SD24s are configured to generate regular interrupts every sampling instant.

The following are the $\Sigma\Delta$ channels associations:

- SD0P0 and SD0N0 $\rightarrow$ Voltage V1
- SD1P0 and SD1N0 $\rightarrow$ Current I1
- SD2P0 and SD2N0 $\rightarrow$ Current IN (Neutral)

4.2 The Foreground Process

The foreground process includes the initial set up of the MSP430 hardware and software immediately after a device RESET. Figure 6 shows the flowchart for this process.

![Flowchart of the Foreground Process](image-url)
The initialization routines involve the setup of the analog to digital converter, clock system, general purpose input/output (GPIO) port pins, timer, LCD, and the USCI_A1 for universal Asynchronous receiver/transmitter (UART) functionality. A check is made to see if the main power is OFF and the device goes into LPM0. During normal operation, the background process notifies the foreground process through a status flag every time a frame of data is available for processing. This data frame consists of accumulation of energy for 1 second. This is equivalent to accumulation of 50 or 60 cycles of data samples synchronized to the incoming voltage signal. In addition, a sample counter keeps track of how many samples have been accumulated per frame period. This count can vary as the software synchronizes with the incoming mains frequency. The data samples set consist of processed current, voltage, active, and reactive energy. All values are accumulated in separate 48-bit registers to further process and obtain the RMS and mean values.

4.2.1 Formulae

This section briefly describes the formulae used for the voltage, current, and energy calculations.

4.2.1.1 Voltage and Current

As discussed in the previous sections simultaneous voltage and current samples are obtained from three independent ΣΔ converters at a sampling rate of 4096 Hz. Track of the number of samples that are present in 1 second is kept and used to obtain the RMS values for voltage and current for each phase.

\[ V_{RMS} = K_v \sqrt{\frac{\sum_{n=1}^{Sample\ count} v(n)^2}{Sample\ count}} \]
\[ I_{RMS} = K_i \sqrt{\frac{\sum_{n=1}^{Sample\ count} i(n)^2}{Sample\ count}} \]

\( v(n) \) = Voltage sample at a sample instant ‘n’
\( i(n) \) = Current sample at a sample instant ‘n’
Sample count = Number of samples in 1 second
\( K_v \) = Scaling factor for voltage
\( K_i \) = Scaling factor for current

4.2.1.2 Power and Energy

Power and energy are calculated for a frame’s worth of active and reactive energy samples. These samples are phase corrected and passed on to the foreground process that uses the number of samples (sample count) and uses the formulae listed below to calculate total active and reactive powers.

\[ P_{ACT} = K_p \sqrt{\frac{\sum_{n=1}^{Sample\ count} v(n) \times i(n)}{Sample\ count}} \]
\[ P_{REACT} = K_p \sqrt{\frac{\sum_{n=1}^{Sample\ count} v_90(n) \times i(n)}{Sample\ count}} \]

\( v_90(n) \) = Voltage sample at a sample instant ‘n’ shifted by 90°
The consumed energy is then calculated based on the active power value for each frame in similar way as the energy pulses are generated in the background process except that:

\[ E_{ACT} = P_{ACT} \times \text{Sample count} \]

For reactive energy, the 90° phase shift approach is used for two reasons:
- This allows us to measure the reactive power accurately down to very small currents.
- This conforms to international specified measurement method.

Since the frequency of the mains varies, it is important to first measure the mains frequency accurately and then phase shift the voltage samples accordingly. This is discussed in Section 4.3.3.

The phase shift consists of an integer part and a fractional part, the integer part is realized by providing an N samples delay. The fractional part is realized by a fractional delay filter (refer to: Phase compensation).

4.3 The Background Process

The background process uses the ΣΔ interrupt as a trigger to collect voltage and current samples (three values in total). These samples are further processed and accumulated in dedicated 48-bit registers. The background function deals mainly with timing critical events in software. Once sufficient samples (1 second worth) have been accumulated then the foreground function is triggered to calculate the final values of \( V_{RMS} \), \( I_{RMS} \), power and energy. The background process is also wholly responsible for energy proportional pulses, frequency and power factor calculation for each phase. Figure 7 shows the flow diagram of the background process.
The following sections discuss the various elements of electricity measurement in the background process.

### 4.3.1 Voltage and Current Signals

The Sigma Delta Converter has a fully differential input; therefore, no added DC offset is needed to precondition a signal, which is the case with most single ended converters.
The output of the Sigma Delta is a signed integer. Any stray DC offset value is removed independently for V and I by subtracting a long term DC tracking filter’s output from each ΔΣ sample. This long term DC tracking filter is synchronized to the mains cycle to yield a highly stable output.

The resulting instantaneous voltage and current samples are used to generate the following information:

- Accumulated squared values of voltage and current for \( V_{\text{RMS}} \) and \( I_{\text{RMS}} \) calculations.
- Accumulated energy samples to calculate Active Energy.
- Accumulated energy samples with current and 90° phase shifted voltage to calculate Reactive Energy.

These accumulated values are processed by the foreground process.

### 4.3.2 Phase Compensation

The Current Transformer (CT) when used as a sensor and the input circuit’s passive components together introduces an additional phase shift between the current and voltage signals that needs compensation. The \( \Delta \Sigma \) converter has built in hardware delay that can be applied to individual samples when grouped. This can be used to provide the phase compensation required. This value is obtained during calibration and loaded on to the respective PRELOAD register for each converter. Figure 8 shows the application of PRELOAD (SD24PREx).

![Figure 8. Phase Compensation Using PRELOAD Register](image)

The fractional delay resolution is a function of input line frequency (\( f_{\text{IN}} \)), OSR and the sampling frequency (\( f_S \)).

\[
\text{Delay resolution} \text{Deg} = \frac{360^\circ \times f_{\text{IN}}}{\text{OSR} \times f_S} = \frac{360^\circ \times f_{\text{IN}}}{f_M}
\]

In the current application for input frequency of 60 Hz, OSR of 256 and sampling frequency of 4096, the resolution for every bit in the preload register is about 0.02° with a maximum of 5.25° (maximum of 255 steps). Since the sampling of the 3 channels are group triggered, an often method used is to apply 128 steps of delay to all channels and then increasing or decreasing from this base value. This allows ± delay timing to compensate for phase lead or lag. This puts the practical limit in the current design to ± 2.62°. When using CTs that provide a larger phase shift than this maximum, an entire sample delay along with fractional delay must be provided. This phase compensation can also be modified on the fly to accommodate temperature drifts in CTs.

### 4.3.3 Frequency Measurement and Cycle Tracking

The instantaneous I and V signals for each phase are accumulated in 48 bit registers. A cycle tracking counter and sample counter keep track of the number of samples accumulated. When approximately one second’s worth of samples have been accumulated, the background process stores these 48-bit registers and notifies the foreground process to produce the average results like RMS and power values. Cycle boundaries to trigger the foreground averaging process are used since it gives very stable results.

For frequency measurements, a straight line interpolation is created between the zero crossing voltage samples. Figure 9 depicts the samples near a zero cross and the process of linear interpolation.
Since noise spikes can also cause errors, therefore, the rate of change check to filter out the possible erroneous signals is used and make sure that the two points interpolated from are genuine zero crossing points. For example, if you have two negative samples, a noise spike can make one of them positive and therefore making the negative and positive pair looks as if there is a zero crossing.

The resultant cycle to cycle timing goes through a weak low pass filter to further smooth out cycle to cycle variations. This results in a stable and accurate frequency measurement tolerant of noise.

### 4.3.4 LED Pulse Generation

In electricity meters, the energy consumed is normally measured in fraction of Kilo Watt Hour (KWh) pulses. This information can be used to accurately calibrate any meter or to report measurement during normal operation. In order to serve both these tasks efficiently, the microcontroller has to accurately generate and record the number of these pulses. It is a general requirement to generate these pulses with relatively little jitter. Although, time jitters are not an indication of bad accuracy, as long as the jitter is averaged out it would give a negative indication on the overall accuracy of the meter.

The average power to generate the energy pulses is used. The average power (calculated by the foreground process) is accumulated every $\Sigma\Delta$ interrupt. This is equivalent to converting it to energy. Once the accumulated energy crosses a threshold, a pulse is generated. The amount of energy above this threshold is kept and new energy amount is added on top of it in the next interrupt cycle. Since the average power tends to be a stable value, this way of generating energy pulses is very steady and free of jitter.

The threshold determines the energy “tick” specified by the power company and is a constant. For example, this can be in KWh. In most meters, the pulses per KWh decide this energy tick. For example in this application, the number of pulses generated per KWh is set to 1600 for active and reactive energies. The energy “tick” in this case is 1KWh or 1600. Energy pulses are generated and also indicated via LEDs on the board. Port pins are toggled for the pulses with control over the pulse width for each pulse. Figure 10 shows the flow diagram for pulse generation.
Figure 10. Pulse Generation for Energy Indication

The average power is in units of 0.01W and 1KWh threshold is defined as

\[
1\text{KWh threshold} = \frac{1}{0.01} \times 1\text{KW} \times \text{(Number of interrupts/sec)} \times \text{(number of seconds in 1 Hr)} \\
= 100000 \times 4096 \times 3600 = 0x15752A00000
\]

5 Energy Meter Demo

The energy meter evaluation module (EVM) associated with this application report has the MSP430F6736 and demonstrates energy measurements. The complete demonstration platform consists of the EVM that can be easily hooked to any test system, metrology software and a PC GUI, which will be used to view results and perform calibration.

5.1 EVM Overview

The following figures of the EVM best describe the hardware. Figure 11 is the top view of the energy meter. Figure 12 discusses the location of various pieces of the EVM based on functionality.
Figure 11. Top View of the Single Phase Energy Meter EVM
5.1.1 Connections to the Test Set Up or AC Voltages

AC voltage or currents can be applied to the board for testing purposes at these points.

- LINE and NEUTRAL for voltage inputs, connect to Line and Neutral voltages respectively. This can be up to 240 V AC, 50 Hz and 60 Hz. Currently available on top of the terminal block.
• CUR1+ and CUR1- are the current inputs after the sensors. When CT or shunts are used, make sure the voltages across CUR1+ and CUR1- does not exceed 920 mV. Not currently used on the EVM.
• CUR2+ and CUR2- can also be used as current inputs after the sensors. When CT or shunts are used, make sure the voltages across CUR2+ and CUR2- does not exceed 920 mV. Currently connected to a CT.

In order to read active energy pulses for accuracy measurements, there are several options available on the board. The related pulse rate is 1600 pulses per kWh by default, but is configurable via the energy library.
• Optical output via LED1.
• Non-isolated electrical pulse via ACT header. The left pin is the signal, and the right pin is GND.
• Isolated pulses via JP7. The optoisolator used will close the circuit between these two pins on an active pulse

Figure 13 shows the various connections that need to be made to the test set up for proper functionality of the EVM.

**Figure 13. Top View of the EVM With Test Setup Connections**

If a test setup needs to be connected, the connections have to be made according to the EVM design. Figure 13 shows the connections from the top view. L and N correspond to the voltage inputs from the test setup. I+ and I- corresponds to one set of current inputs and I’+ and I’- corresponds to the second set of current inputs. Although the EVM hardware and software supports measurement for the second current, the EVM obtained from Texas Instruments do not have the second sensor and any current inputs must be connected to I+ and I- only. If additional sensor needs to be placed, please use the two bottom left slots close to terminals I’+ and I’-. Additional connections need to be made to connect the output of these sensors to points CUR1+ and CUR1- on the PCB.

### 5.1.2 Power Supply Options and Jumper Settings

The entire board and the UART communication is powered by a single DC voltage rail (DVCC). DVCC can be derived either via JTAG, external power or the AC mains through the capacitive power supply. Various jumper headers and jumper settings are present to add to the flexibility to the board. Headers JP1 to JP15 constitute the entire headers on the EVM shown above. Some of these headers require that jumpers be placed appropriately for blocks to function correctly. Table 1 indicates the functionality of each jumper on the board and the associated functionality.

<table>
<thead>
<tr>
<th>Header Name</th>
<th>Main Functionality</th>
<th>Valid Use-case</th>
<th>Comments</th>
</tr>
</thead>
<tbody>
<tr>
<td>JP1</td>
<td>JTAG power selection</td>
<td>Jumper placed during JTAG programming</td>
<td>Jumper on &quot;INTERNAL&quot; selects JTAG voltage from the attached USB FET. Jumper on &quot;EXTERNAL&quot; selects JTAG voltage from an external source.</td>
</tr>
<tr>
<td>JP4</td>
<td>DVCC Power Selection</td>
<td>Jumper placed during operation</td>
<td>Jumper on &quot;VCC_PL&quot; selects voltage from the cap drop power supply on board, and jumper on &quot;VCC_EXT&quot; selects an external input from JP3.</td>
</tr>
<tr>
<td>JP3</td>
<td>External power input</td>
<td>Not a jumper header</td>
<td>When using an external source for DVCC, attach VCC and GND here.</td>
</tr>
<tr>
<td>JP2</td>
<td>Current Sensor Reference</td>
<td>Connects the -ve input of the current sensor sigma delta to AGND</td>
<td>Place a jumper if Current transformers are used. Do not place jumper if shunt is used. Needs to be placed on the EVM if used as provided</td>
</tr>
<tr>
<td>AUX1</td>
<td>AUXVCC1 selection</td>
<td>Connects AUXVCC1 to GND and input of external supply of AUXVCC1.</td>
<td>Jumper must be present if AUXVCC1 is not used. When removed, it can be used to supply an external voltage to AUXVCC1.</td>
</tr>
<tr>
<td>AUX2</td>
<td>AUXVCC2 selection</td>
<td>Connects AUXVCC2 to GND and input of external supply of AUXVCC2.</td>
<td>Jumper must be present if AUXVCC2 is not used. When removed, it can be used to supply an external voltage to AUXVCC2.</td>
</tr>
</tbody>
</table>
Table 1. Header Names and Jumper Settings on the F6736 EVM (continued)

<table>
<thead>
<tr>
<th>Header Name</th>
<th>Main Functionality</th>
<th>Valid Use-case</th>
<th>Comments</th>
</tr>
</thead>
<tbody>
<tr>
<td>AUX3</td>
<td>AUXVCC3 selection</td>
<td>Connects AUXVCC3 to DVCC and input of external supply of AUXVCC3.</td>
<td>Jumper can be placed if AUXVCC3 needs to be used; when removed it can be used to supply an external voltage to AUXVCC3.</td>
</tr>
<tr>
<td>JP7</td>
<td>Isolated active energy pulses</td>
<td>Not a jumper header</td>
<td>Isolated output to probe the active energy output pulses using external equipment.</td>
</tr>
<tr>
<td>JP8</td>
<td>Isolated reactive energy pulses</td>
<td>Not a jumper header</td>
<td>Isolated output to probe the reactive energy output pulses using external equipment.</td>
</tr>
<tr>
<td>SV1</td>
<td>DVCC Power Tap</td>
<td>Not a jumper header</td>
<td>Used to measure DVCC or connect power to an external module.</td>
</tr>
<tr>
<td>SV2</td>
<td>DGND Power Tap</td>
<td>Not a jumper header</td>
<td>Used to measure DGND or connect power to an external module.</td>
</tr>
<tr>
<td>RF1 + RF2</td>
<td>TI EMK Headers</td>
<td>Not a jumper header</td>
<td>Used to connect a standard TI Wireless Evaluation Module Kit (EMK) such as the CC2530 or CC3000</td>
</tr>
<tr>
<td>ACT</td>
<td>Non-isolated active energy pulses + GND</td>
<td>Not a jumper header</td>
<td>Not isolated from AC voltage. Do not connect external equipment if external isolation is not present. The left pin is the signal, and the right pin is GND.</td>
</tr>
<tr>
<td>REACT</td>
<td>Non-isolated reactive energy pulses + GND</td>
<td>Not a jumper header</td>
<td>Not isolated from AC voltage. Do not connect external equipment if external isolation is not present. The left pin is the signal, and the right pin is GND.</td>
</tr>
</tbody>
</table>

5.2 Loading the Example Code

The source code is developed in the IAR environment using IAR compiler version 6.x. If earlier versions of IAR are used, the project files will not open. If later than 6.x versions are used when project is loaded, a prompt to create a back-up will be issued and you can click YES to proceed. There are two parts to the energy metrology software: the toolkit that contains a library of mostly mathematics routines and the main code that has the source and include files.

5.2.1 Opening the Project

The “source” folder structure is shown in Figure 14.

```
Source

<table>
<thead>
<tr>
<th>Name</th>
<th>Type</th>
</tr>
</thead>
<tbody>
<tr>
<td>emeter-ng</td>
<td>File Folder</td>
</tr>
<tr>
<td>emeter-toolkit</td>
<td>File Folder</td>
</tr>
</tbody>
</table>
```

Figure 14. Source Folder Structure

The folder “emeter-ng” contains multiple project files. For this application, the *emeter-6736.ewp* project file is to be used. The folder “emeter-toolkit” has corresponding project file *emeter-toolkit-6736.ewp*. Choose only the projects that have the succeeding terms 6736 for this application. For first time use, it is recommended that both the projects be completely rebuild.

1. Open IAR window.
2. find and load the project *emeter-toolkit-6736.ewp*.
3. Rebuild all.
4. Close the existing workspace and open the main project *emeter-6736.ewp*.
5. Rebuild all and load this on to the MSP430F6736, which is shown in Figure 15.
Figure 15. Toolkit Compilation in IAR
6 Results and Calibration

If the procedures and configurations are complete in the previous two sections, the results can be observed and based on these; calibration can be performed. Calibration is key to any meter’s performance and is absolutely necessary for every meter to go through this process. Initially every meter would exhibit different accuracies due to silicon-silicon differences, sensor accuracies and other passive tolerances. In order to nullify their effects, every meter should be calibrated. Simple procedures to accomplish this process are shown in this section. For any calibration to be performed accurately there should be an accurate source available. The source should be able to generate any desired voltage, current and phase shifts (between V and I) or power factors. In addition to an accurate source, there should also be a reference meter that acts as an arbitrator between the source and the meter being calibrated. This section discusses a simple and effective method of calibration of this 1-phase EVM.

A PC GUI can be downloaded from the associated zip file, which is located at the following URL: http://www.ti.com/lit/zip/slaa517. After decompressing the zip file, a folder by the name “GUI” will have all the necessary files to run this application.
6.1 Viewing Results

Once the meter is turned ON, the results can be easily viewed using this GUI by connecting the RS-232 header to the PC. Open the executable *calibrator.exe* in the GUI folder.

Under correct connections, you should see the GREEN filled button under “Comms”. If there are problems with connections or if the code is not configured correctly, the button will be RED in color. Click on the green button to see the meter results immediately on the GUI.
Results and Calibration

The configuration of the meter can also be viewed by clicking on “Meter features” (Example only) to get the screen shown in Figure 19.

![Figure 18. Meter Status](image)

Figure 18. Meter Status

The configuration of the meter can also be viewed by clicking on “Meter features” (Example only) to get the screen shown in Figure 19.

![Figure 19. Meter 1 Features](image)

Figure 19. Meter 1 Features

Results can also be viewed as pulses fed back to any energy meter test setup. Energy pulses for total active and total reactive energies are available at JP9 and JP12 (ACT) and JP14 and JP13 (REACT). In addition, the pulses go through on-board opto-couplers that might be necessary for interface to any test equipment. Look at Table 1 and choose the right header for energy pulses.

6.2 Calibrating the Meter

The meter can be calibrated easily using the included GUI. Gain correction for voltage, current and active power can be done simultaneously. However, phase correction for active power is an additional step.
6.2.1 Gain Correction

Gain correction for voltage, current and active power can be done simultaneously and the procedure is discussed below.

1. Connect the meter to the test setup with known voltage and currents.
2. Connect GUI to view results for voltage, current, active power, and so forth.
3. Click on Manual cal seen in Figure 18 to give you this screen.

4. The values that need to be entered are in % and these values are calculated by the following formula. For any particular voltage, the value will be:

\[ \% VAL = \left( \frac{V_{\text{observed}}}{V_{\text{desired}}} - 1 \right) \times 100 \]

5. Negative values are accepted in the voltage and current fields and the same procedure is applicable for other voltages and currents. For voltages, enter in field “Voltage” and for currents, enter in field Current (low). After these values are entered, click on Update meter.

6. Gain correction for active power is done differently; the accuracy obtained from any test system when pulses are fed from the meter is the most accurate method.

7. Measure accuracy in the reference meter of the test system. This gives the true accuracy of the meter for active energy.

8. Enter the “% accuracy” seen as-is in the Active (low) field. Click on update meter to do a gain correction on Phase A.

6.2.2 Phase Correction

Phase correction has to be done differently and the following is the procedure.

1. Set voltage and current values to the same as Gain correction and introduce a known phase shift between voltage and current to +60°.

2. See % error on the test setup. If errors are not acceptable, enter correction factors in the Phase (low) field. Only increments and decrements should be entered in this field and preferably start with 1 or -1 to determine the direction of correction. Click “Update meter”.

Figure 20. Meter 1 Errors (for manual correction)
3. Measure error again to see if error has increased or decreased. If error has decreased, continue to add desired increments until you arrive at an error close to zero, else add decrements.

4. Click on “Update meter” every time a modification is made to this field.

5. Change the phase now to -60° and check if this error is still acceptable. If not, fine tune the values of Phase (low) again. Ideally, errors should be symmetric for same phase shift on lag and lead conditions.

Once the meter has been calibrated it is possible to see these calibrated values for reference. Click on “Meter calibration factors” to get this screen (sample values only).

![Meter calibration factors](image)

Figure 21. Meter Calibration Factors

If the calibration procedure goes wrong, such that the calibration values are either negative or zero, further calibration of the meter should be stopped and code must be reloaded onto the device and the calibration routine repeated.

6.2.3 Metrology Results

In this discussion, metrology results are shown. Current transformers have been used, however, the code supports shunt resistors as well. Figure 22 shows the results for current that is varied from 50 mA to 100 A exhibiting a 2000:1 dynamic range. Table 2 shows the values for the error at room temperature.

<table>
<thead>
<tr>
<th>Current (Amps)</th>
<th>-60° (PF =-0.5) Error (%)</th>
<th>0° (PF =1) Error (%)</th>
<th>60° (PF=0.5) Error (%)</th>
</tr>
</thead>
<tbody>
<tr>
<td>0.05</td>
<td>0.077</td>
<td>0.064</td>
<td>-0.382</td>
</tr>
<tr>
<td>0.1</td>
<td>0.103</td>
<td>0.064</td>
<td>-0.382</td>
</tr>
<tr>
<td>0.25</td>
<td>-0.16</td>
<td>0</td>
<td>0.1231</td>
</tr>
<tr>
<td>0.5</td>
<td>-0.051</td>
<td>-0.002</td>
<td>0.405</td>
</tr>
<tr>
<td>1</td>
<td>-0.057</td>
<td>-0.019</td>
<td>0.128</td>
</tr>
<tr>
<td>2</td>
<td>-0.07</td>
<td>-0.025</td>
<td>0.058</td>
</tr>
<tr>
<td>5</td>
<td>0.026</td>
<td>-0.013</td>
<td>-0.019</td>
</tr>
<tr>
<td>10</td>
<td>0.025</td>
<td>-0.004</td>
<td>-0.057</td>
</tr>
<tr>
<td>20</td>
<td>0.0533</td>
<td>-0.0107</td>
<td>-0.075</td>
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<tr>
<td>30</td>
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<tr>
<td>40</td>
<td>0.1177</td>
<td>-0.032</td>
<td>-0.117</td>
</tr>
<tr>
<td>50</td>
<td>0.174</td>
<td>-0.032</td>
<td>-0.15</td>
</tr>
<tr>
<td>60</td>
<td>0.1677</td>
<td>-0.01</td>
<td>-0.174</td>
</tr>
</tbody>
</table>
### Table 2. Energy Measurement Accuracy With Error in (%) (continued)

<table>
<thead>
<tr>
<th>Current (Amps)</th>
<th>-60° (PF = -0.5) Error (%)</th>
<th>0° (PF = 1) Error (%)</th>
<th>60° (PF = 0.5) Error (%)</th>
</tr>
</thead>
<tbody>
<tr>
<td>70</td>
<td>0.189</td>
<td>0.0037</td>
<td>-0.18</td>
</tr>
<tr>
<td>80</td>
<td>0.21</td>
<td>0.0037</td>
<td>-0.195</td>
</tr>
<tr>
<td>90</td>
<td>0.21</td>
<td>0.025</td>
<td>-0.195</td>
</tr>
<tr>
<td>100</td>
<td>0.224</td>
<td>0.011</td>
<td>-0.188</td>
</tr>
</tbody>
</table>

**Figure 22. Measurement Accuracy Across Current**

7 **References**

- *MSP430 Family Mixed-Signal Microcontroller* ([SLAA024](#))
- *MSP430x5xx/MSP430x6xx Family User’s Guide* ([SLAU208](#))
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